IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

licants: Koichi Ohto, et al.

Examiner:

Ori Nadav

fial No:

10/767,786

Art Unit:

2811

Filed:

January 29, 2004

Docket:

17408

For:

SEMICONDUCTOR DEVICE,

Dated:

July 8, 2005

AND PRODUCTION METHOD FOR MANUFACTURING SUCH SEMICONDUCTOR DEVICE

Confirmation No. 7289

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE TO COMMUNICATION OF JUNE 21, 2005

Sir:

Pursuant to the communication of June 21, 2005, applicants provisionally elect without traverse the Claims of Group I, i.e., Claims 1-38 for continued prosecution herein.

Claims 1-82 are present in the above-captioned application and have been subjected to restriction under 35 U.S.C. §121. Specifically, the Official Action avers that the following inventions are present in the claims:

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8(a)

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Box 1450, Alexandria, VA 22313-1450, on July 8, 2005

Dated: July 8, 2005

Richard J. Danyko

Group I, Claims 1-38, drawn to a semiconductor device, classified in class 257,

subclass 635.

Group II, Claims 39-82, drawn to a process of making a semiconductor device.

classified in class 438, subclass 22+.

It is the Examiner's position that the inventions listed as Groups I and II are distinct

from each other.

In response to the Examiner's requirement for restriction, Applicants provisionally

elect without traverse to prosecute the subject matter of Group I, Claims 1-38. However,

Applicants reserve the right under 35 U.S.C. § 121 to file one or more divisional applications

directed to the non-elected claims in this application.

Further, as requested by the examiner, the applicants elect the embodiment of

Figure 2 for consideration at the present time.

Claims 1-15 are directed to the first and second embodiments shown in Figs. 2 and

8, respectively. Claims 16-26 are directed to the first embodiment of Fig. 2, and claims 27-38 are

directed to the second embodiment of Fig. 2.

In view of the foregoing, an examination on the merits of the elected claims, at an

early date, is earnestly solicited.

Respectfully submitted,

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TRANSMITTAL LETTER (General - Patent Pending)

Docket No. 17408

Koichi Ohto, et al.

Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
10/767,786	January 29, 2004	Ori Nadav	23389	2811	7289

Title: SEMICONDUCTOR DEVICE, AND PRODUCTION METHOD FOR

MANUFACTURING SUCH SEMICONDUCTOR DEVICE

COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Response to Communication of June 21, 2005

in the above identified application.

\mathbf{X}	No	addi	tional	fee	is	req	uired	J.
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☐ A check in the amount of

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Dated: July 8, 2005

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RJD:ej

CC:

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> July 8, 2005 (Date)

> > e of Person Mailing Correspondence

Richard J. Danyko

Typed or Printed Name of Person Mailing Correspondence